

Initial Product/Process Change Notification Document #:IPCN24980X Issue Date: 30 Sep 2022

Title of Change:	-	EMC change from Samsung SI7200DX2 to KCC KTMC1050GFB / Kehua KHG300X for Transistor TO-220 package in Tongfu Microelectronics Co., Ltd, China (TFME)		
Proposed First Ship date:	09 Mar 2023 or earlier	09 Mar 2023 or earlier if approved by customer		
Contact Information:	Contact your local onse	Contact your local onsemi Sales Office or <u>Jim.Yeh@onsemi.com</u> or <u>khairil.fk@onsemi.com</u>		
PCN Samples Contact:	Contact your local onsemi Sales Office. Sample requests are to be submitted no later than 30 days from the date of first notification, Initial PCN or Final PCN, for this change. Samples delivery timing will be subject to request date, sample quantity and special customer packing/label requirements.			
Type of Notification:	This is an Initial Product/Process Change Notification (IPCN) sent to customers. An IPCN is an advance notification about an upcoming change and contains general information regarding the change details and devices affected. It also contains the preliminary reliability qualification plan. The completed qualification and characterization data will be included in the Final Product/Process Change Notification (FPCN). This IPCN notification will be followed by a Final Product/Process Change Notification (FPCN) at least 90 days prior to implementation of the change. In case of questions, contact < <u>PCN.Support@onsemi.com</u> >			
Marking of Parts/ Traceability of Change:	No change in marking, <i>i</i>	No change in marking, Affected products will be identified by date code		
Change Category:	Assembly Change	Assembly Change		
Change Sub-Category(s):	Material Change			
Sites Affected:				
onsemi Sites		External Foundry/Subcon Sites		
None		Tongfu Microelectronics Co. Ltd, China (TFME)		
Description and Purpose:				
onsemi wishes to inform our customers	of a change in mold com	pounds used for the	devices listed in this IPCN.	
This change is a result of an End-of-Life	notification received from	m Samsung for sever	al of their Samsung Mold Compounds	
All other aspects of the impacted produ	icts (form, fit, function) w	vill remain unchanged	1.	
There is no product marking change as	a result of this change			
	Fro	m	То	
	SI7200DX2		KTMC1050GFB Supplier: KCC	
	(1720)			

## onsemi

## **Qualification Plan:**

## QV DEVICE NAME: MJE5852G PACKAGE: TO-220

Test	Specification	Condition	Interval
HTRB	JESD22-A108	Ta = 85°C, 80% rated	1008 hrs
HTSL	JESD22-A103	Ta = 150°C	1008 hrs
IOL	MIL-STD-750 (M1037) AEC-Q101	Ta = +25°C, delta Tj=100°C On/off = 3.5 min	8572 cyc
TC	JESD22-A104	Ta = -65°C to +150°C	1000 cyc
uHAST	JESD22-A118	Ta = 130°C, 85% RH, 18.8psig, unbiased	96 hrs
H3TRB	JEDS22 A101	Ta = 85°C, 85% RH, V=80% rated V	1008 hrs
RSH	JESD22- B106	Ta = 265C, 10 sec	
SD	JSTD002	Ta = 245C, 10 sec	
PD	JESD22 B100	Per POD / Case Outline, Verify physical dimensions to specifications	0 hr
DPA	AEC Q101-004 Section 4	Following TC / H3TRB / HTRB	
ED	Electrical Distribution / Characterization	Tri Temperature, Per datasheet	0 hr
TR	JESD-24-3, 24-4, 24-6 as appropriate	per device specification, pre & post process change	0 hr

## List of Affected Parts:

**Note:** Only the standard (off the shelf) part numbers are listed in the parts list. Any custom parts affected by this PCN are shown in the customer specific PCN addendum in the PCN email notification, or on the **PCN Customized Portal**.

Part Number	Qualification Vehicle
MJE5850G	MJE5852G
MJE5851G	MJE5852G
MJE5852G	MJE5852G
D44H11G	MJE5852G
D44H8G	MJE5852G
D44VH10G	MJE5852G
D45H11G	MJE5852G
D45H8G	MJE5852G
D45VH10G	MJE5852G
TIP29AG	MJE5852G
TIP29BG	MJE5852G
TIP29CG	MJE5852G
BDX33BG	MJE5852G
BDX33CG	MJE5852G



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BDX53BG	MJE5852G
BDX53CG	MJE5852G
BU406G	MJE5852G
MJE15028G	MJE5852G
MJE15029G	MJE5852G
MJE15030G	MJE5852G
MJE15031G	MJE5852G
MJE15032G	MJE5852G
MJE15033G	MJE5852G
MJE15035G	MJE5852G
MJE2955TG	MJE5852G
MJE3055TG	MJE5852G
MJE5730G	MJE5852G
MJE5731AG	MJE5852G
MJE5731G	MJE5852G
TIP102G	MJE5852G
TIP107G	MJE5852G
TIP110G	MJE5852G
TIP111G	MJE5852G
TIP112G	MJE5852G
TIP115G	MJE5852G
TIP116G	MJE5852G
TIP117G	MJE5852G
TIP120G	MJE5852G
TIP121G	MJE5852G
TIP122G	MJE5852G
TIP127G	MJE5852G
TIP30CG	MJE5852G
TIP31AG	MJE5852G
TIP31BG	MJE5852G
TIP31CG	MJE5852G
TIP31G	MJE5852G
TIP32G	MJE5852G
TIP41AG	MJE5852G



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TIP41BG	MJE5852G
TIP41CG	MJE5852G
TIP42AG	MJE5852G
TIP42BG	MJE5852G
TIP42CG	MJE5852G
TIP42G	MJE5852G